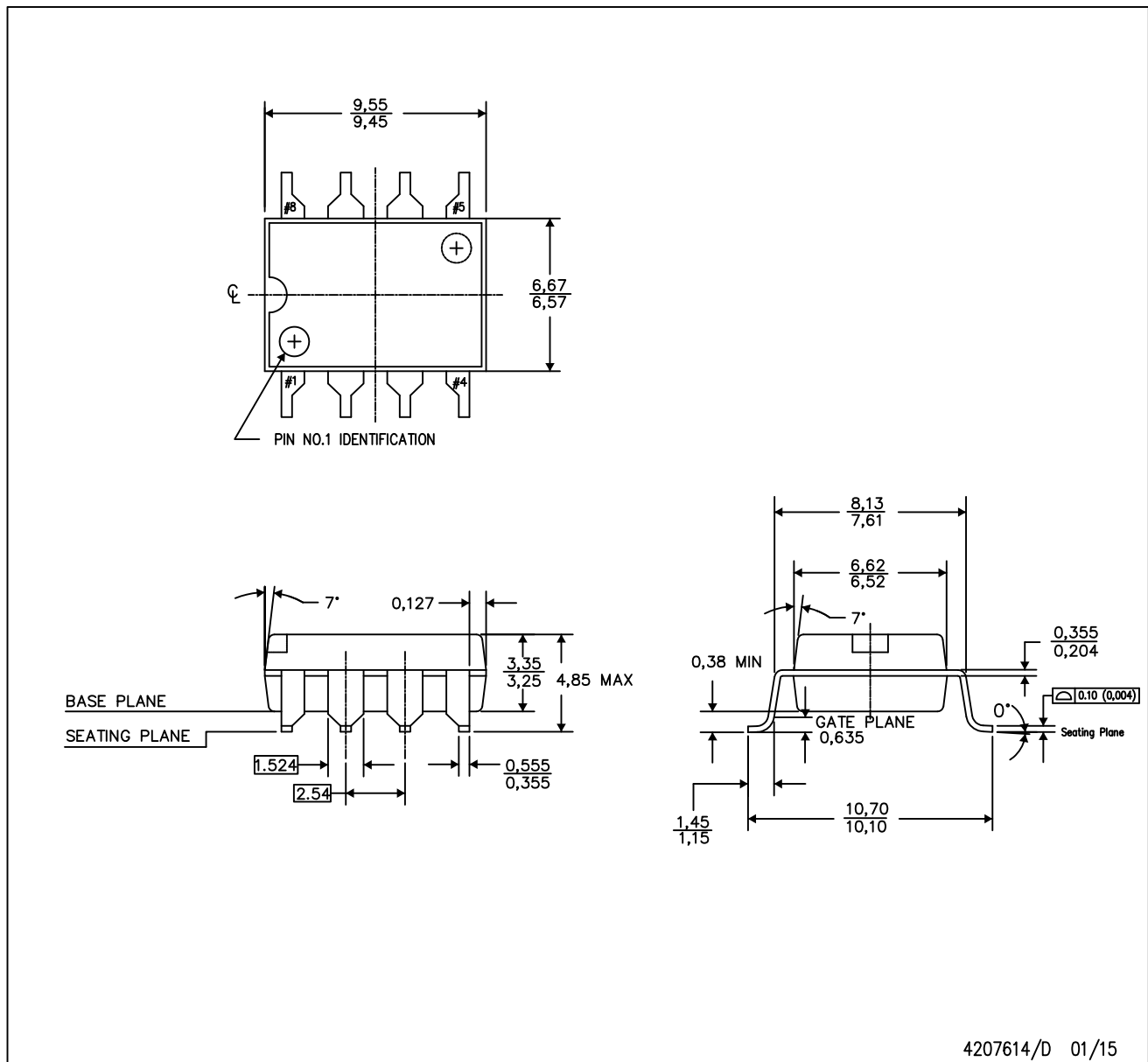



DUB (R-PDSO-G8)

PLASTIC SMALL-OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ANSI Y14.5 M-1982.
 - B. This drawing is subject to change without notice.
 -  Dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.254mm.

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